

## ADOPTION NOTICE

EIA-364-71, "Solder Wicking (Wave Solder Technique) Test Procedure for Electrical Connectors and Sockets", published by the Electronic Components Industry Association (ECIA), (ECIA, 1111 Alderman Dr., Suite 400, Alpharetta, GA 30005-4175, <http://www.eciaonline.org>), was adopted on 21 March 2012 for use by the Department of Defense (DoD). Proposed changes by DoD activities must be submitted to the DoD Adopting Activity: DLA Land and Maritime, P.O. Box 3990, Columbus, OH 43218-3990, ATTN: VAI or [RectangularConnector@dla.mil](mailto:RectangularConnector@dla.mil). Copies of this document are available from IHS, 15 Inverness Way East, Englewood, CO 80112. Telephone: 800-854-7179, email: [global@ihs.com](mailto:global@ihs.com), or online at <http://www.global.ihs.com>.

## CONCLUDING MATERIAL

Custodians:  
Army – CR  
Navy – AS  
Air Force – 85  
DLA - CC

Preparing activity:  
DLA - CC

(Project 5935-2012-158)

NOTE: The activities listed above were interested in this document as of the date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using the ASSIST Online database at <https://assist.daps.dla.mil>.

